



PATENT

Attorney Docket No.: SAM-0313CIP

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Kyoung-woo Lee, *et al.*

Examiner: Nguyen, Ha T.

Serial No.: 10/625,007

Group Art Unit: 2812

Filing Date: July 23, 2003

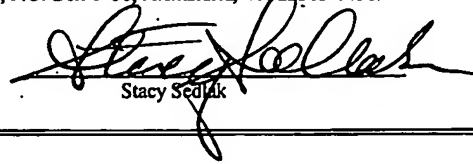
Title: METHOD OF FABRICATING DUAL DAMASCENE INTERCONNECTIONS
OF MICROELECTRONIC DEVICE USING HYBRID LOW K-DIELECTRIC
AND CARBON-FREE INORGANIC FILLER

CERTIFICATE OF MAILING UNDER 37 C.F.R. § 1.8

I hereby certify that this correspondence is being deposited with the United States Post Office as First Class Mail on the date indicated below in an envelope addressed to Mail Stop AF, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

1-10-06

Date


Stacy Sedlak

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT AFTER FINAL REJECTION

Sir:

This is in response to the final Office Action mailed on November 15, 2005 and is filed within the shortened statutory period of three months. It is requested that the following amendments be entered and that the following remarks be considered.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 10 of this paper.